

DELPHI SERIES



Delphi Series E48SH, 120W Eighth Brick Family DC/DC Power Modules: 48V in, 12V/10A out

The Delphi Series E48SH Eighth Brick, 48V input, single output, isolated DC/DC converters are the latest offering from a world leader in power systems technology and manufacturing — Delta Electronics, Inc. This product family is available in either a through-hole or surface-mounted package and provides up to 120 watts of power or 50A of output current (1.2V and below) in an industry standard footprint and pinout. The E48SH converter operates from an input voltage of 36V to 75V and is available in output voltages from 1.0V to 15V. Efficiency is 93% for the 12V output at full load. With creative design technology and optimization of component placement, these converters possess outstanding electrical and thermal performance, as well as extremely high reliability under highly stressful operating conditions. All models are fully protected from abnormal input/output voltage, current, and temperature conditions. The Delphi Series converters meet all safety requirements with basic insulation.

FEATURES

- High efficiency: 93% @ 12V/10A
- Size:
 - 58.4mm x 22.8mm x 9.5mm
(2.30"x0.90"x0.37") w/o heat-spreader
 - 58.4mm x 22.8mm x 12.7mm
(2.30"x0.90"x0.5") with heat-spreader
- Industry standard pin out
- Fixed frequency operation
- Input UVLO, Output OTP, OCP, OVP
- Monotonic startup into normal and Pre-biased loads
- 2250V Isolation and basic insulation
- No minimum load required
- SMD and through-hole versions
- No negative current during power or enable on/off
- ISO 9001, TL 9000, ISO 14001, QS 9000, OHSAS 18001 certified manufacturing facility
- UL/cUL 60950 (US & Canada) recognized, and TUV (EN60950) certified
- CE mark meets 73/23/EEC and 93/68/EEC directive

OPTIONS

- Positive On/Off logic
- Short pin lengths available
- External Synchronization
- Output OVP latch mode
- Through hole pins with Heat spreader

APPLICATIONS

- Telecom/DataCom
- Wireless Networks
- Optical Network Equipment
- Server and Data Storage
- Industrial/Test Equipment

TECHNICAL SPECIFICATIONS

($T_A=25^\circ\text{C}$, airflow rate=300 LFM, $V_{in}=48\text{Vdc}$, nominal V_{out} unless otherwise noted.)

PARAMETER	NOTES and CONDITIONS	E48SH12010 (Standard)		
		Min.	Typ.	Max.
ABSOLUTE MAXIMUM RATINGS				Units
Input Voltage				
Continuous				80
Transient (100ms)	100ms			100
Operating Ambient Temperature		-40		85
Storage Temperature		-55		125
Input/Output Isolation Voltage				2250
INPUT CHARACTERISTICS				
Operating Input Voltage		36	75	Vdc
Input Under-Voltage Lockout				
Turn-On Voltage Threshold		33	34	35
Turn-Off Voltage Threshold		31	32	33
Lockout Hysteresis Voltage		1	2	3
Maximum Input Current	100% Load, 36Vin			A
No-Load Input Current				90
Off Converter Input Current		3	10	mA
Inrush Current(I^2t)				1 A^2s
Input Reflected-Ripple Current	P-P thru 12 μH inductor, 5Hz to 20MHz	20		mA
Input Voltage Ripple Rejection	120 Hz	60		dB
OUTPUT CHARACTERISTICS				
Output Voltage Set Point	$V_{in}=48\text{V}$, $I_o=I_o.\text{max}$, $T_c=25^\circ\text{C}$	11.88	12.00	12.12
Output Voltage Regulation				
Over Load	$I_o=I_o.\text{min}$ to $I_o.\text{max}$		± 10	± 20
Over Line	$V_{in}=36\text{V}$ to 75V		± 10	± 20
Over Temperature	$T_c=40^\circ\text{C}$ to 115°C		± 50	mV
Total Output Voltage Range	over sample load, line and temperature	11.76		12.24
Output Voltage Ripple and Noise	5Hz to 20MHz bandwidth			
Peak-to-Peak	Full Load, 1 μF ceramic, 10 μF tantalum	40	80	mV
RMS	Full Load, 1 μF ceramic, 10 μF tantalum	10	20	mV
Operating Output Current Range		0		10
Output DC Current-Limit Inception	Output Voltage 10% Low	110		140
DYNAMIC CHARACTERISTICS				
Output Voltage Current Transient	48V, 10 μF Tan & 1 μF Ceramic load cap, 0.1A/ μs			
Positive Step Change in Output Current	50% $I_o.\text{max}$ to 75% $I_o.\text{max}$	110	200	mV
Negative Step Change in Output Current	75% $I_o.\text{max}$ to 50% $I_o.\text{max}$	110	200	mV
Settling Time (within 1% V_{out} nominal)		100		us
Turn-On Transient				
Start-Up Time, From On/Off Control		15	25	ms
Start-Up Time, From Input		20	30	ms
Maximum Output Capacitance	Full load; no overshoot of V_{out} at startup			5000 μF
EFFICIENCY				
100% Load		92	93	%
60% Load		92	93	%
ISOLATION CHARACTERISTICS				
Input to Output				2250 Vdc
Isolation Resistance				10 M Ω
Isolation Capacitance			1500	pF
FEATURE CHARACTERISTICS				
Switching Frequency	For others	185	200	225 kHz
	For NRFL	160	175	195 kHz
ON/OFF Control, Negative Remote On/Off logic				
Logic Low (Module On)	$V_{on/off}$ at $I_{on/off}=1.0\text{mA}$			1.2 V
Logic High (Module Off)	$V_{on/off}$ at $I_{on/off}=0.0\text{\mu A}$	3	50	V
ON/OFF Control, Positive Remote On/Off logic				
Logic Low (Module Off)	$V_{on/off}$ at $I_{on/off}=1.0\text{mA}$			1.2 V
Logic High (Module On)	$V_{on/off}$ at $I_{on/off}=0.0\text{\mu A}$	3	50	V
ON/OFF Current (for both remote on/off logic)	$I_{on/off}$ at $V_{on/off}=0.0\text{V}$			1 mA
Leakage Current (for both remote on/off logic)	Logic High, $V_{on/off}=15\text{V}$			50 uA
Output Voltage Trim Range	$P_{out} \leq$ max rated power, trim up curve refer to figure4	-20		10 %
Output Voltage Remote Sense Range	$P_{out} \leq$ max rated power, refer to figure4			10 %
Output Over-Voltage Protection	Over full temp range; % of nominal V_{out}	13.8		16.2 V
GENERAL SPECIFICATIONS				
MTBF	$I_o=80\%$ of $I_o.\text{max}$; 300LFM @25C	2.2		M hours
Weight	Without heat spreader	25		grams
Weight	With heat spreader	36.6		grams
Over-Temperature Shutdown (Without heat spreader)	Refer to Figure 22 for Hot spot 1 location (48Vin,80% I_o , 200LFM,Airflow from Vin- to Vin+)		130	°C
Over-Temperature Shutdown (With heat spreader)	Refer to Figure 24 for Hot spot 2 location (48Vin,80% I_o , 200LFM,Airflow from Vin- to Vin+)		118	°C
Over-Temperature Shutdown (NTC resistor)			125	°C

Note: Please attach thermocouple on NTC resistor to test OTP function, the hot spots' temperature is just for reference.

ELECTRICAL CHARACTERISTICS CURVES

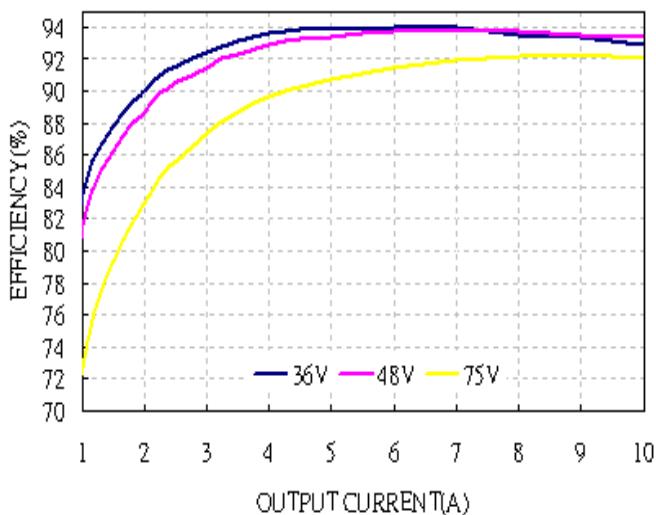


Figure 1: Efficiency vs. load current for minimum, nominal, and maximum input voltage at 25°C

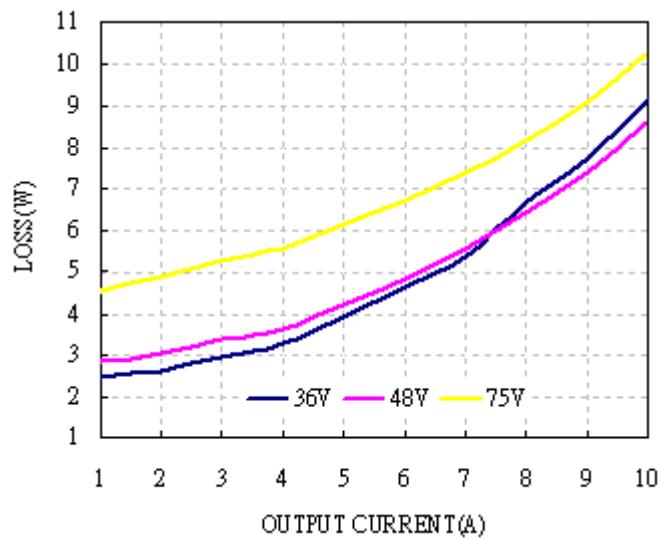


Figure 2: Power dissipation vs. load current for minimum, nominal, and maximum input voltage at 25°C.

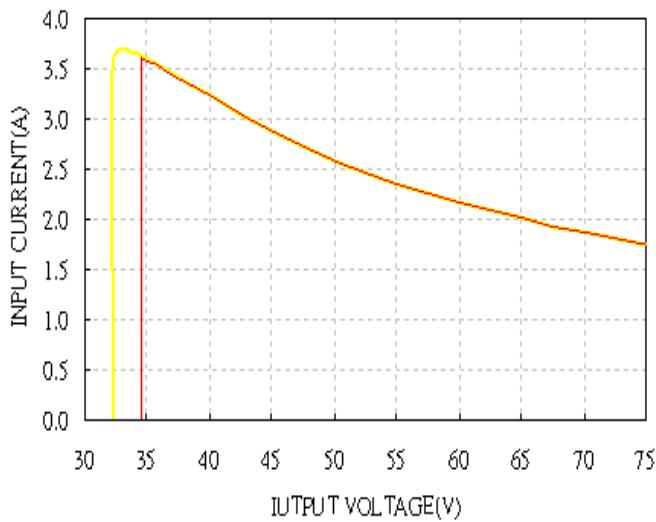


Figure 3: Typical full load input characteristics at room temperature

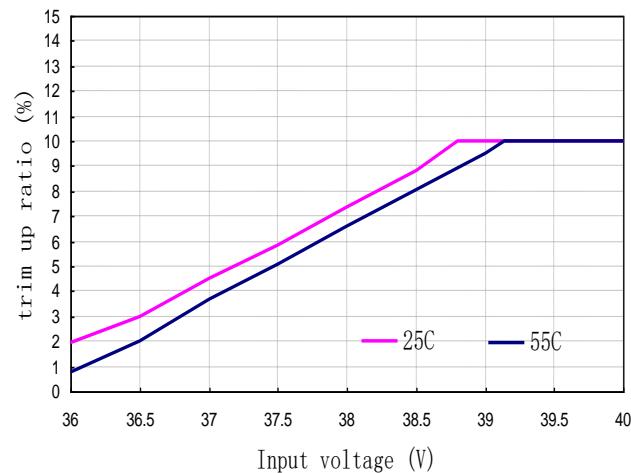


Figure 4: trim up curve at full load, 200LFM, 25°C and 200LFM, 55°C

ELECTRICAL CHARACTERISTICS CURVES

For Negative Remote On/Off Logic

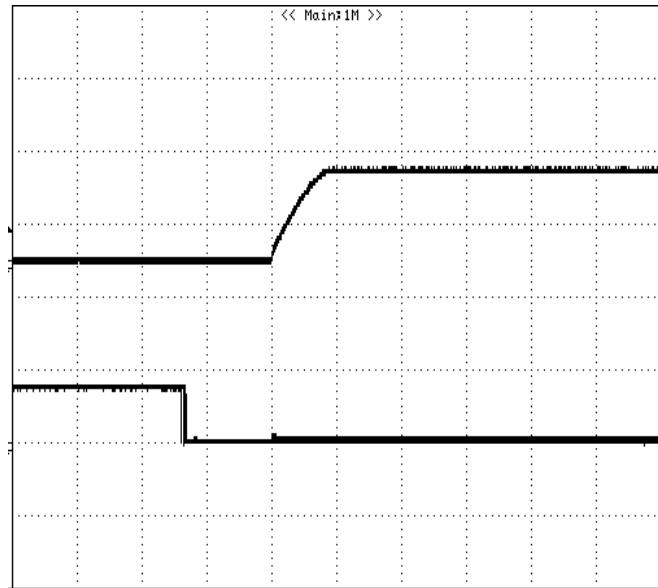


Figure 5: Turn-on transient at zero load current (5 ms/div). Vin=48V. Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF input, 5V/div

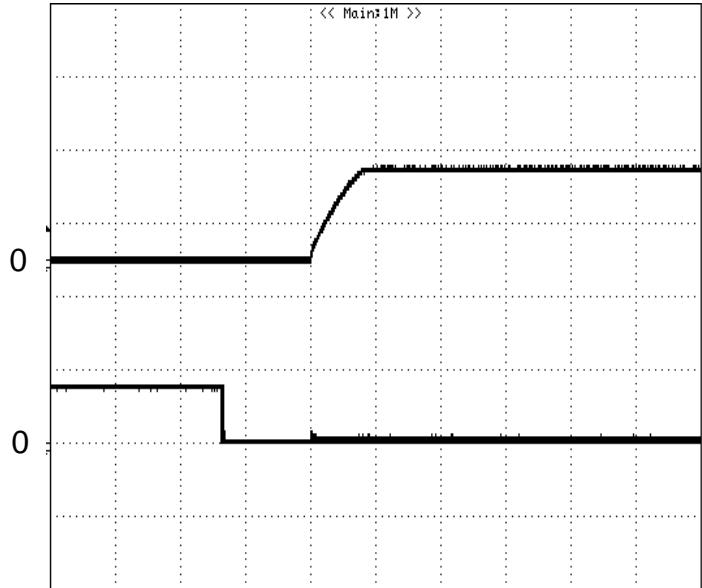


Figure 6: Turn-on transient at full rated load current (constant current load) (5 ms/div). Vin=48V. Top Trace: Vout, 10V/div; Bottom Trace: ON/OFF input, 5V/div

For Input Voltage Start up

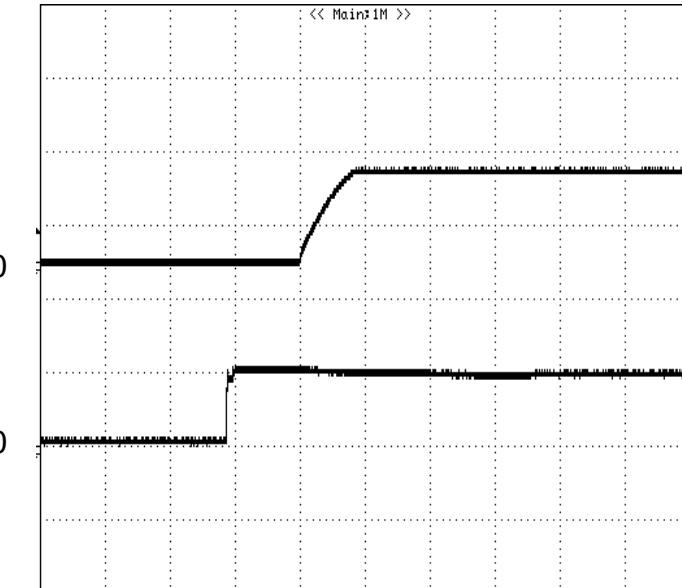


Figure 7: Turn-on transient at zero load current (5 ms/div). Vin=48V. Top Trace: Vout, 10V/div, Bottom Trace: input voltage, 50V/div

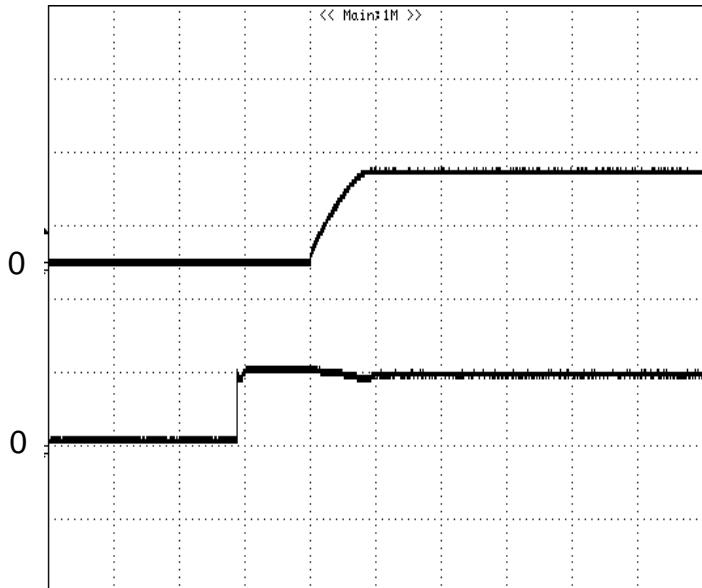


Figure 8: Turn-on transient at full rated load current (constant current load) (5 ms/div). Vin=48V. Top Trace: Vout, 10V/div; Bottom Trace: input voltage, 50V/div

ELECTRICAL CHARACTERISTICS CURVES

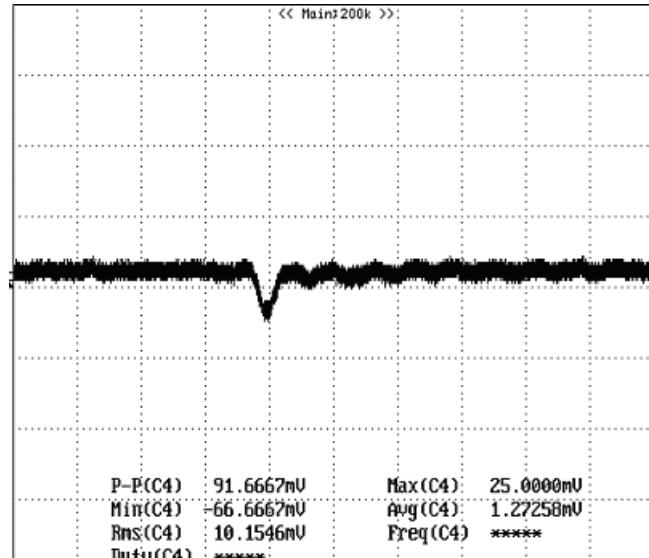
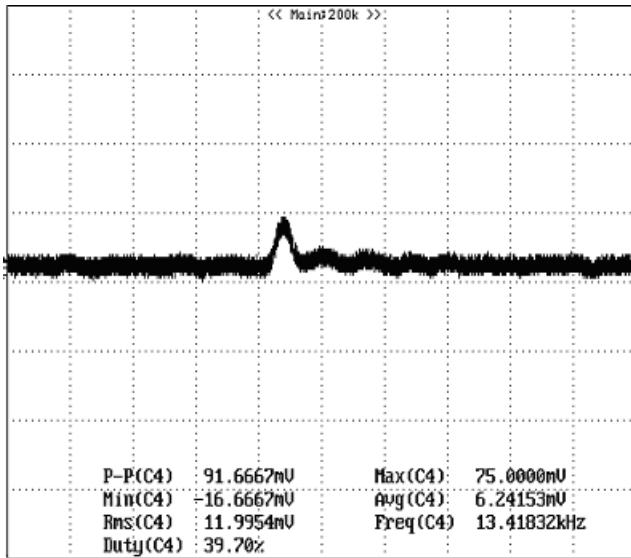


Figure 9: Output voltage response to step-change in load current (75%-50% of I_o , max; $di/dt = 0.1A/\mu s$). Load cap: 10 μF , tantalum capacitor and 1 μF ceramic capacitor. Trace: V_{out} (50mV/div, 100 μs /div), Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module..

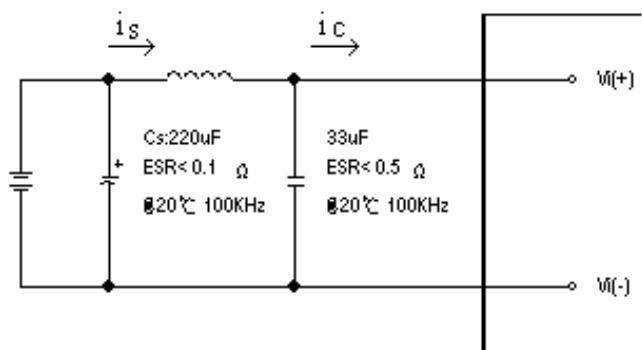


Figure 10: Output voltage response to step-change in load current (50%-75% of I_o , max; $di/dt = 0.1A/\mu s$). Load cap: 10 μF , tantalum capacitor and 1 μF ceramic capacitor. Trace: V_{out} (50mV/div, 100 μs /div), Scope measurement should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module..

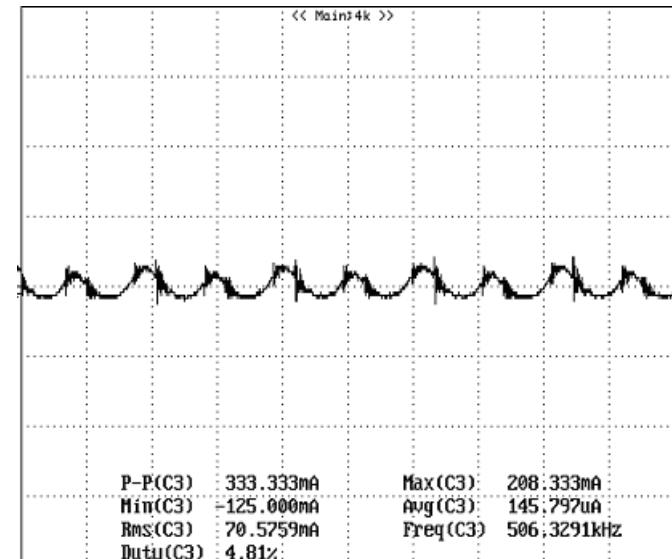


Figure 11: Test set-up diagram showing measurement points for Input Terminal Ripple Current and Input Reflected Ripple Current.

Note: Measured input reflected-ripple current with a simulated source Inductance (L_{TEST}) of 12 μH . Capacitor C_s offset possible battery impedance. Measure current as shown above

ELECTRICAL CHARACTERISTICS CURVES

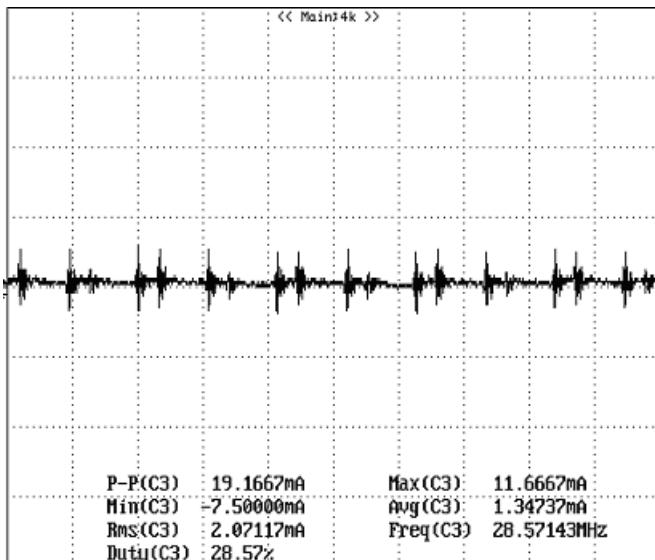


Figure 13: Input reflected ripple current, i_s , through a $12\mu\text{H}$ source inductor at nominal input voltage and rated load current (20 mA/div, 2us/div).

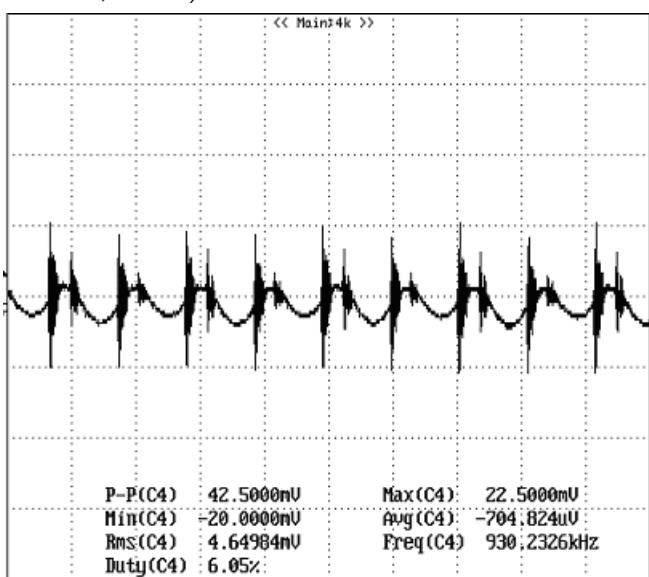


Figure 15: Output voltage ripple at nominal input voltage and rated load current ($I_o=10\text{A}$) (20 mV/div, 2us/div)

Load capacitance: $1\mu\text{F}$ ceramic capacitor and $10\mu\text{F}$ tantalum capacitor. Bandwidth: 20 MHz. Scope measurements should be made using a BNC cable (length shorter than 20 inches). Position the load between 51 mm to 76 mm (2 inches to 3 inches) from the module.

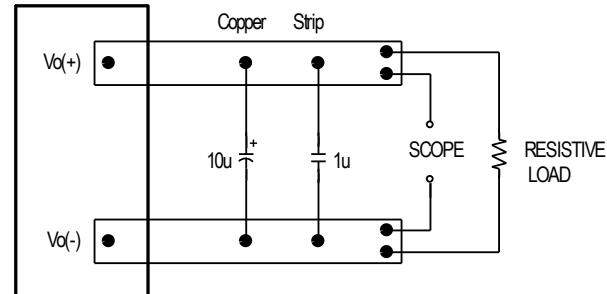


Figure 14: Output voltage noise and ripple measurement test setup

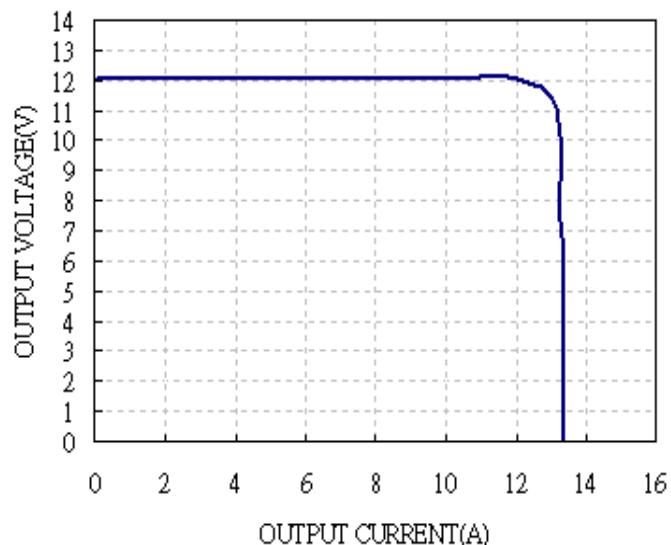


Figure 16: Output voltage vs. load current showing typical current limit curves and converter shutdown points.



DESIGN CONSIDERATIONS

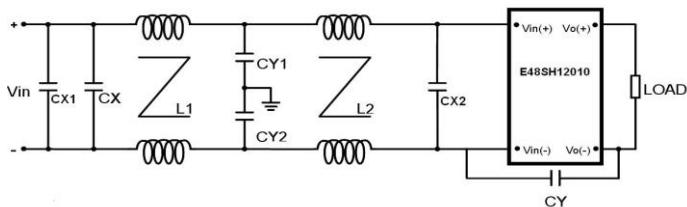
Input Source Impedance

The impedance of the input source connecting to the DC/DC power modules will interact with the modules and affect the stability. A low ac-impedance input source is recommended. If the source inductance is more than a few μ H, we advise adding a 10 to 100 μ F electrolytic capacitor (ESR < 0.7 Ω at 100 kHz) mounted close to the input of the module to improve the stability.

Layout and EMC Considerations

Delta's DC/DC power modules are designed to operate in a wide variety of systems and applications. For design assistance with EMC compliance and related PWB layout issues, please contact Delta's technical support team. An external input filter module is available for easier EMC compliance design. Below is the reference design for an input filter tested with E48SH12010XXXX to meet class B in CISPR 22.

Schematic and Components List



Cx1: 100V/2.2uF * 2 MLCC, Cx=4.7uF MLCC

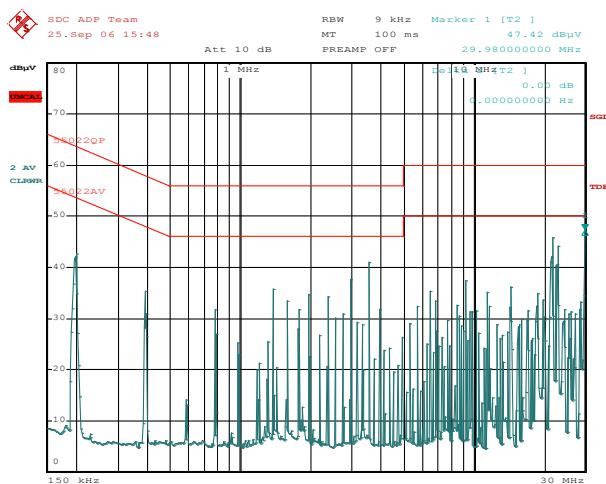
Cx2: 100V/2.2uF MLCC+ 100V/100uF Al cap

Cy: 3000V/3.9nF *2 MLCC, Cy1=Cy2=4.7nF MLCC

L1=0.08mH, L2= 0.85mH

L1 leakage=0.5uH, L2 leakage=4uH

Test Result: Vin=48V, Io=8A,



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Safety Considerations

The power module must be installed in compliance with the spacing and separation requirements of the end-user's safety agency standard, i.e., UL60950, CAN/CSA-C22.2 No. 60950-00 and EN60950: 2000 and IEC60950-1999, if the system in which the power module is to be used must meet safety agency requirements.

Basic insulation based on 75 Vdc input is provided between the input and output of the module for the purpose of applying insulation requirements when the input to this DC-to-DC converter is identified as TNV-2 or SELV. An additional evaluation is needed if the source is other than TNV-2 or SELV.

When the input source is SELV circuit, the power module meets SELV (safety extra-low voltage) requirements. If the input source is a hazardous voltage which is greater than 60 Vdc and less than or equal to 75 Vdc, for the module's output to meet SELV requirements, all of the following must be met:

- The input source must be insulated from the ac mains by reinforced or double insulation.
- The input terminals of the module are not operator accessible.
- If the metal baseplate is grounded, one Vi pin and one Vo pin shall also be grounded.
- A SELV reliability test is conducted on the system where the module is used, in combination with the module, to ensure that under a single fault, hazardous voltage does not appear at the module's output.

When installed into a Class II equipment (without grounding), spacing consideration should be given to the end-use installation, as the spacing between the module and mounting surface have not been evaluated.

The power module has extra-low voltage (ELV) outputs when all inputs are ELV.

This power module is not internally fused. To achieve optimum safety and system protection, an input line fuse is highly recommended. The safety agencies require a normal-blow fuse with 20A maximum rating to be installed in the ungrounded lead. A lower rated fuse can be used based on the maximum inrush transient energy and maximum input current.

Soldering and Cleaning Considerations

Post solder cleaning is usually the final board assembly process before the board or system undergoes electrical testing. Inadequate cleaning and/or drying may lower the reliability of a power module and severely affect the finished circuit board assembly test. Adequate cleaning and/or drying is especially important for un-encapsulated and/or open frame type power modules. For assistance on appropriate soldering and cleaning procedures, please contact Delta's technical support team.

FEATURES DESCRIPTIONS

Over-Current Protection

The E48SH modules include an internal output over-current protection circuit, which will endure current limiting for an unlimited duration during output overload. When the output current exceeds the OCP set point, the current limit function will work by initially reduce duty cycle of the module, the unit will go out of regulation but remains in safe operating area before the output drops below 50%. When output drops below 50%, the modules will automatically shut down and enter hiccup mode.

During hiccup, the modules will try to restart after shutdown. If the overload condition still exists, the module will shut down again. This restart trial will continue until the overload condition is corrected.

Over-Voltage Protection

The modules include an internal output over-voltage protection circuit, which monitors the voltage on the output terminals. If this voltage exceeds the over-voltage set point, the module will shut down and restart after 200mS. latch off mode is optional. Under latch off mode the over-voltage latch is reset by either cycling the input power or by toggling the on/off signal for one second.

Over-Temperature Protection

The over-temperature protection consists of circuitry that provides protection from thermal damage. If the temperature exceeds the over-temperature threshold the module will shut down.

The module will try to restart after shutdown. If the over-temperature condition still exists during restart, the module will shut down again. This restart trial will continue until the temperature is within specification.

Remote On/Off

The remote on/off feature on the module can be either negative or positive logic. Negative logic turns the module on during a logic low and off during a logic high. Positive logic turns the modules on during a logic high and off during a logic low.

Remote on/off can be controlled by an external switch between the on/off terminal and the Vi(-) terminal. The switch can be an open collector or open drain.

For negative logic if the remote on/off feature is not used, please short the on/off pin to $V_{i(-)}$. For positive logic if the remote on/off feature is not used, please leave the on/off pin to floating.

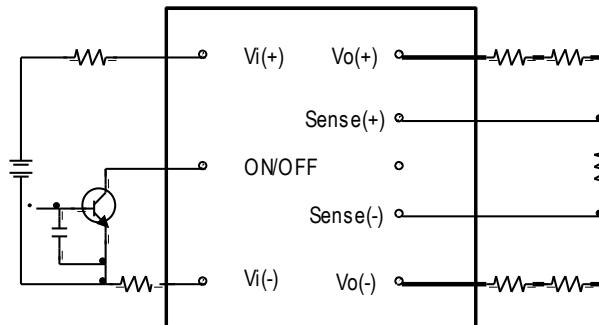


Figure 17: Remote on/off implementation

Remote Sense

Remote sense compensates for voltage drops on the output by sensing the actual output voltage at the point of load. The voltage between the remote sense pins and the output terminals must not exceed the output voltage sense range given here:

$$[V_o(+)-V_o(-)] - [SENSE(+)-SENSE(-)] \leq 10\% \times V_{out}$$

This limit includes any increase in voltage due to remote sense compensation and output voltage set point adjustment (trim).

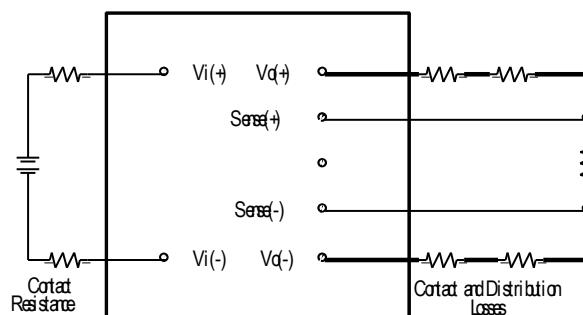


Figure 18: Effective circuit configuration for remote sense operation

If the remote sense feature is not used to regulate the output at the point of load, please connect SENSE(+) to Vo(+) and SENSE(-) to Vo(-) at the module.

The output voltage can be increased by both the remote sense and the trim; however, the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Care should be taken to ensure that the maximum output power does not exceed the maximum rated power.

FEATURES DESCRIPTIONS (CON.)

Output Voltage Adjustment (TRIM)

To increase or decrease the output voltage set point, the modules may be connected with an external resistor between the TRIM pin and either the SENSE(+) or SENSE(-). The TRIM pin should be left open if this feature is not used.

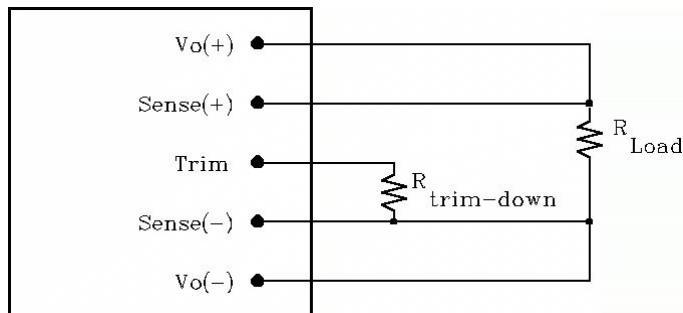


Figure 19: Circuit configuration for trim-down (decrease output voltage)

If the external resistor is connected between the TRIM and SENSE (-) pins, the output voltage set point decreases (Fig.19). The external resistor value required to obtain a percentage of output voltage change $\Delta\%$ is defined as:

$$R_{trim-down} = \frac{511}{\Delta} - 10.2 (K\Omega)$$

Ex. When Trim-down -10%(12Vx0.9=10.8V)

$$R_{trim-down} = \frac{511}{10} - 10.2 = 40.9 (K\Omega)$$

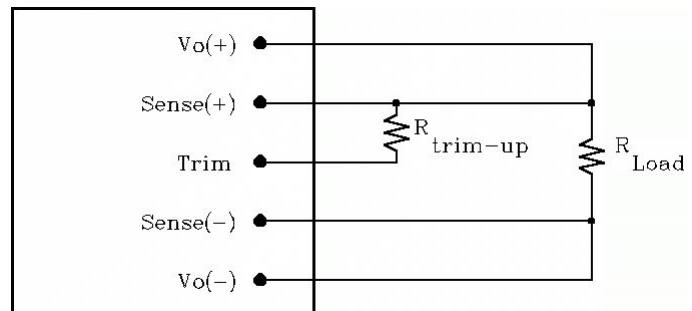


Figure 20: Circuit configuration for trim-up (increase output voltage)

If the external resistor is connected between the TRIM and SENSE (+) the output voltage set point increases (Fig. 20). The external resistor value required to obtain a percentage output voltage change $\Delta\%$ is defined as:

$$R_{trim-up} = \frac{5.11 \times V_o \times (100 + \Delta)}{1.225 \times \Delta} - \frac{511}{\Delta} - 10.22 (K\Omega)$$

Ex. When Trim-up +10%(12Vx1.1=13.2V)

$$R_{trim-up} = \frac{5.11 \times 12 \times (100 + 10)}{1.225 \times 10} - \frac{511}{10} - 10.22 = 489.3 (K\Omega)$$

The output voltage can be increased by both the remote sense and the trim, however the maximum increase is the larger of either the remote sense or the trim, not the sum of both.

When using remote sense and trim, the output voltage of the module is usually increased, which increases the power output of the module with the same output current.

Care should be taken to ensure that the maximum output power of the module remains at or below the maximum rated power.

THERMAL CONSIDERATIONS

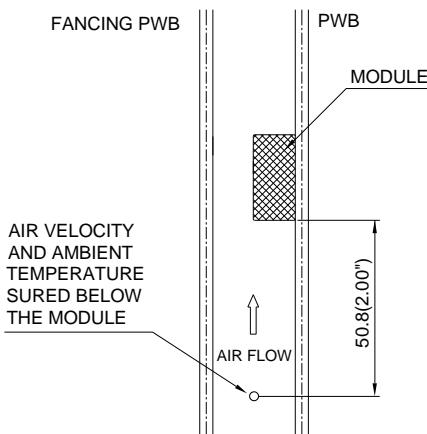
Thermal management is an important part of the system design. To ensure proper, reliable operation, sufficient cooling of the power module is needed over the entire temperature range of the module. Convection cooling is usually the dominant mode of heat transfer.

Hence, the choice of equipment to characterize the thermal performance of the power module is a wind tunnel.

Thermal Testing Setup

Delta's DC/DC power modules are characterized in heated vertical wind tunnels that simulate the thermal environments encountered in most electronics equipment. This type of equipment commonly uses vertically mounted circuit cards in cabinet racks in which the power modules are mounted.

The following figure shows the wind tunnel characterization setup. The power module is mounted on a 185mmX185mm,70 μ m (2Oz),6 layers test PWB and is vertically positioned within the wind tunnel. The space between the neighboring PWB and the top of the power module is constantly kept at 6.35mm (0.25").



Note: Wind Tunnel Test Setup Figure Dimensions are in millimeters and (Inches)

Figure 21: Wind tunnel test setup

Thermal Derating

Heat can be removed by increasing airflow over the module. To enhance system reliability; the power module should always be operated below the maximum operating temperature. If the temperature exceeds the maximum module temperature, reliability of the unit may be affected.

THERMAL CURVES (WITHOUT HEAT SPREADER)

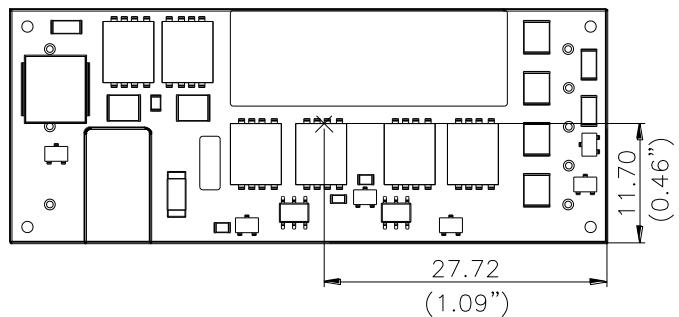


Figure 22: Hot spot 1's temperature measured point.

*The allowed maximum hot spot temperature is defined at 123°C

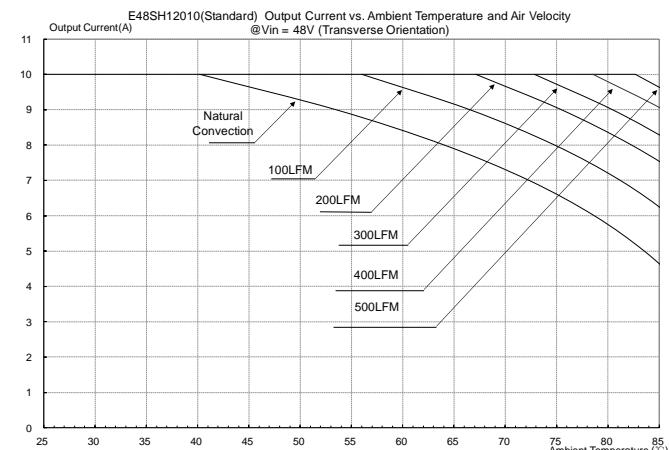


Figure 23: Output current vs. ambient temperature and air velocity @ $V_{in}=48V$ (Transverse Orientation, airflow from V_{in-} to V_{in+} , without heat spreader)

THERMAL CURVES (WITH HEAT SPREADER)

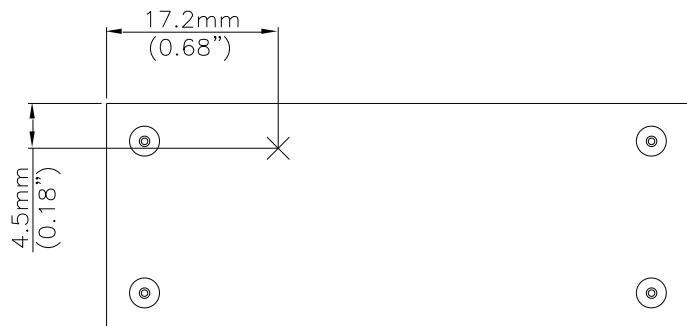


Figure 24: Hot spot 2's temperature measured point.
*The allowed maximum hot spot temperature is defined at 106°C

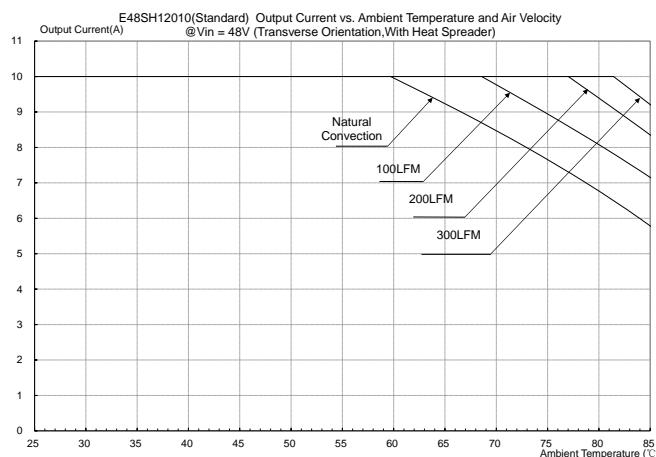
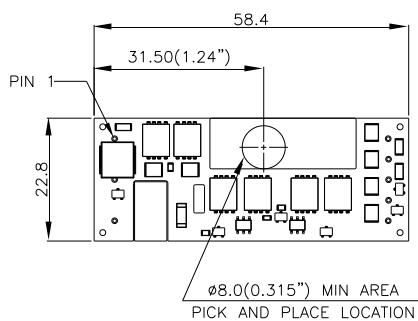


Figure 25: Output current vs. ambient temperature and air velocity
@Vin=48V (Transverse Orientation, airflow from Vin- to Vin+, with heat spreader)

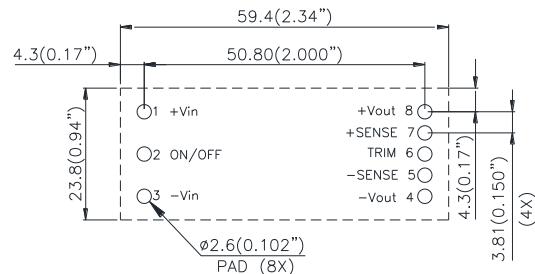


PICK AND PLACE LOCATION(SMD)



NOTES:
 DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
 TOLERANCES: $X.Xmm \pm 0.5mm$ ($X.XX$ in. ± 0.02 in.)
 $X.XXmm \pm 0.25mm$ ($X.XXX$ in. ± 0.010 in.)

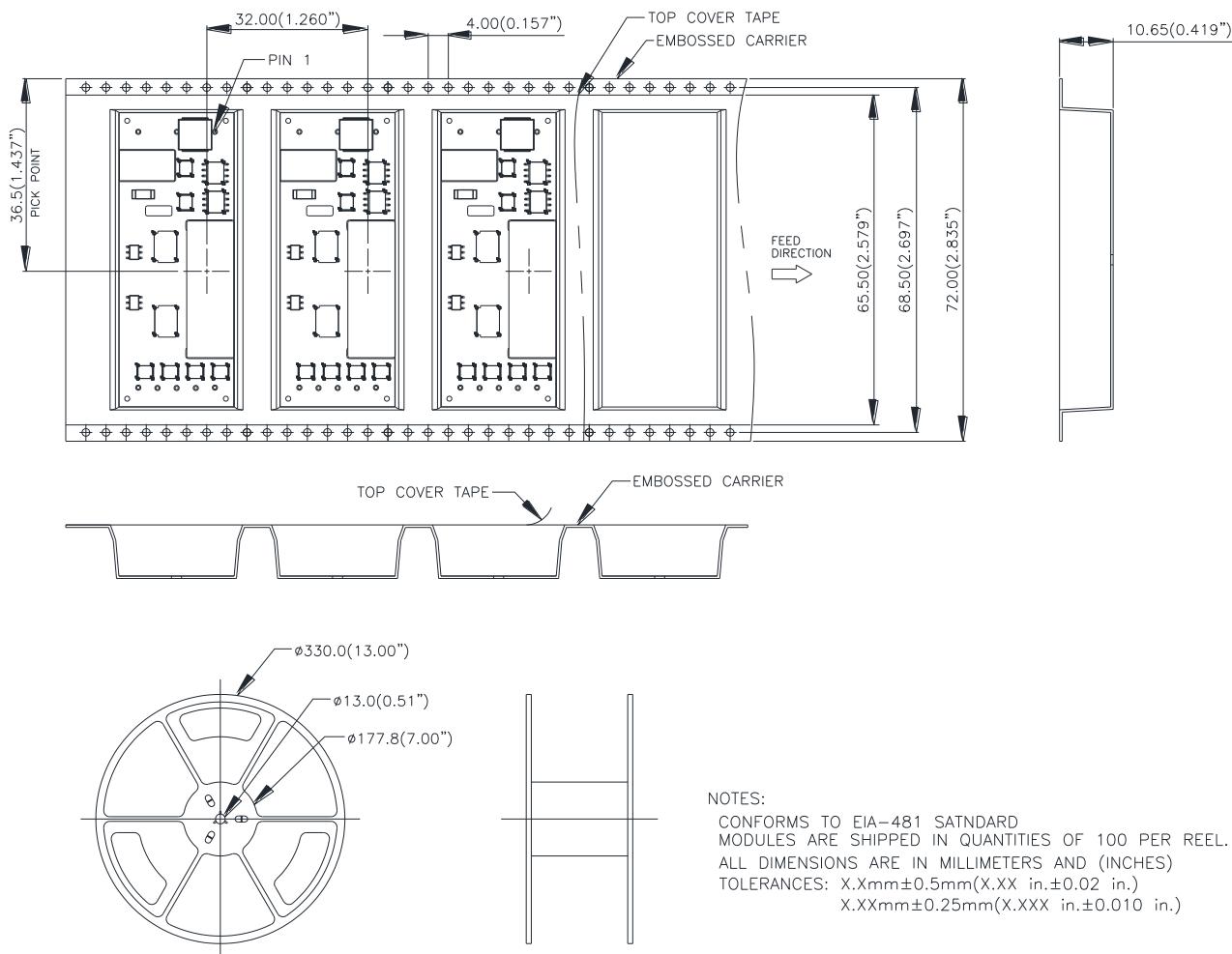
RECOMMENDED PAD LAYOUT (SMD)



RECOMENDED P.W.B. PAD LAYOUT

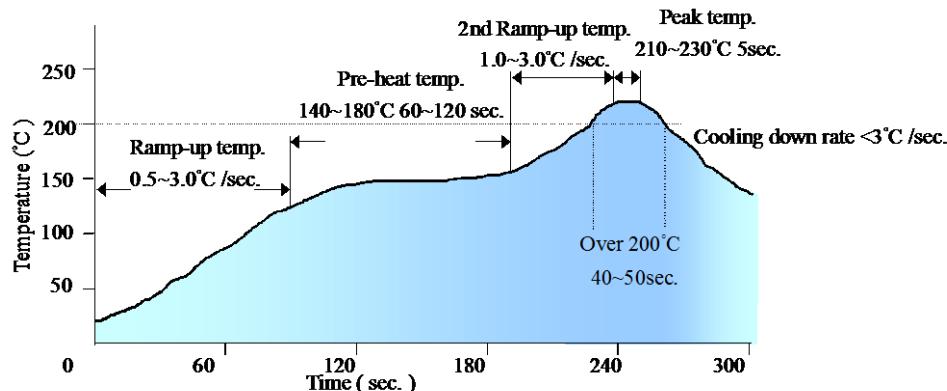
NOTES:
 DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
 TOLERANCES: $X.Xmm \pm 0.5mm$ ($X.XX$ in. ± 0.02 in.)
 $X.XXmm \pm 0.25mm$ ($X.XXX$ in. ± 0.010 in.)

SURFACE-MOUNT TAPE & REEL



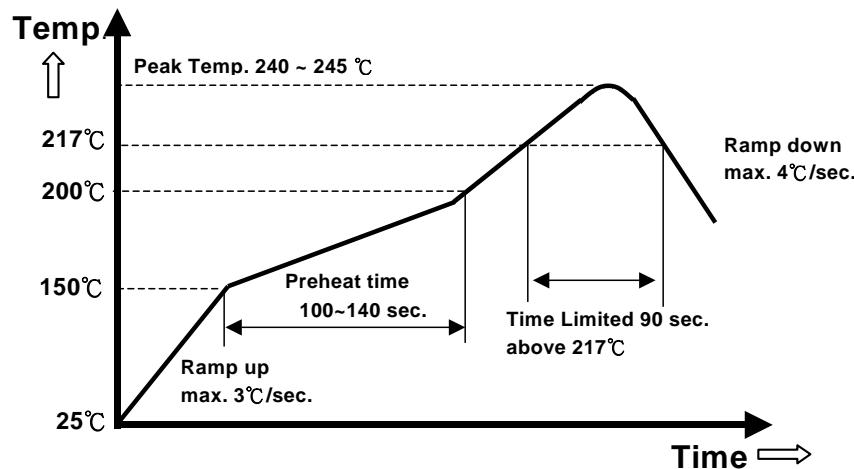
NOTES:
 CONFORMS TO EIA-481 STANDARD
 MODULES ARE SHIPPED IN QUANTITIES OF 100 PER REEL.
 ALL DIMENSIONS ARE IN MILLIMETERS AND (INCHES)
 TOLERANCES: $X.Xmm \pm 0.5mm$ ($X.XX$ in. ± 0.02 in.)
 $X.XXmm \pm 0.25mm$ ($X.XXX$ in. ± 0.010 in.)

LEADED (Sn/Pb) PROCESS RECOMMEND TEMP. PROFILE(SMD)



Note: The temperature refers to the pin of E48SH, measured on the pin +Vout joint.

LEAD FREE (SAC) PROCESS RECOMMEND TEMP. PROFILE(SMD)

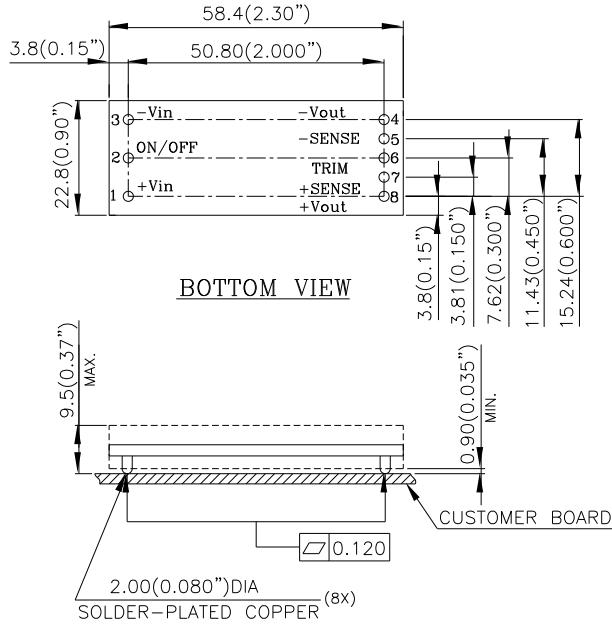


Note: The temperature refers to the pin of E48SH, measured on the pin +Vout joint.



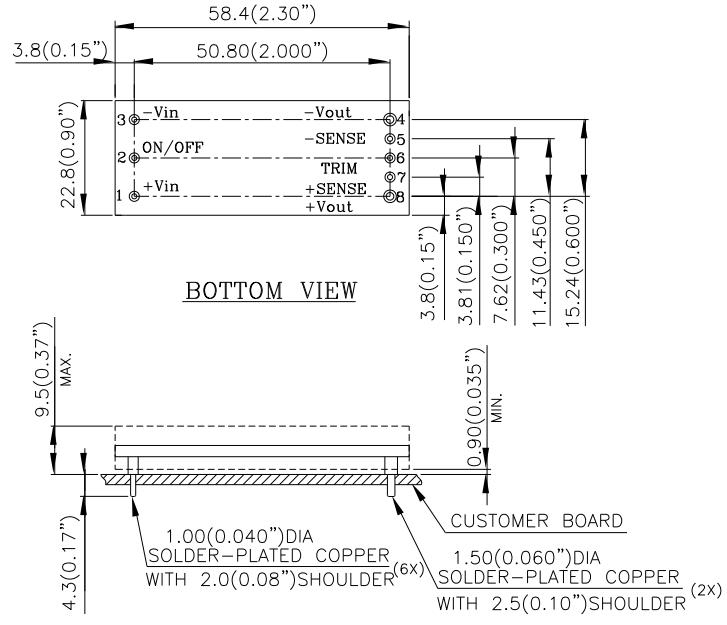
MECHANICAL DRAWING (WITHOUT HEATSPREADER)

SURFACE-MOUNT MODULE



SIDE VIEW

THROUGH-HOLE MODULE



SIDE VIEW

NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: $X.Xmm \pm 0.5mm$ ($X.XX \text{ in.} \pm 0.02 \text{ in.}$)

$X.XXmm \pm 0.25mm$ ($X.XXX \text{ in.} \pm 0.010 \text{ in.}$)

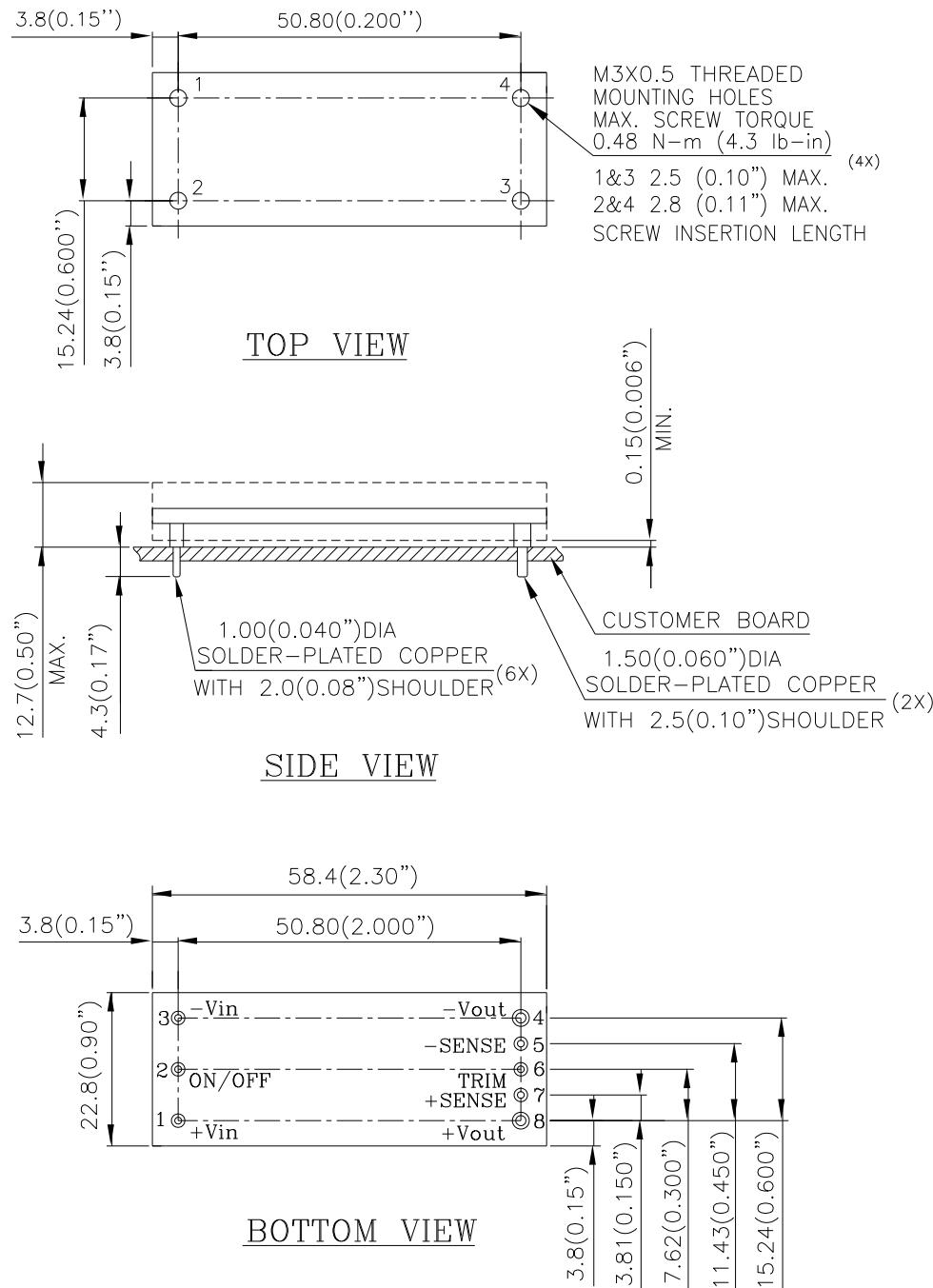
<u>Pin No.</u>	<u>Name</u>	<u>Function</u>
1	+Vin	Positive input voltage
2	ON/OFF	Remote ON/OFF
3	-Vin	Negative input voltage
4	-Vout	Negative output voltage
5	-SENSE	Negative remote sense
6	TRIM	Output voltage trim
7	+SENSE	Positive remote sense
8	+Vout	Positive output voltage

Notes: All pins are copper alloy with matte tin plated over Nickel under-plating.



MECHANICAL DRAWING (WITH HEATSPREADER)

* For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.



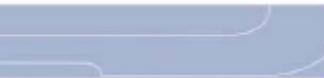
NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

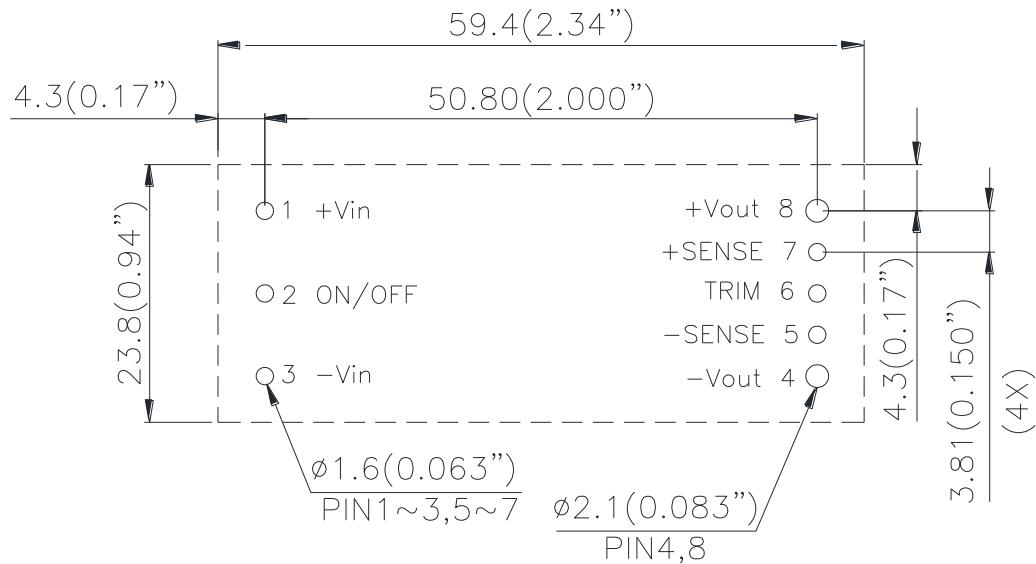
TOLERANCES: X.Xmm \pm 0.5mm (X.XX in. \pm 0.02 in.)

X.XXmm \pm 0.25mm (X.XXX in. \pm 0.010 in.)

Notes: All pins are copper alloy with matte tin plated over Nickel under-plating.



RECOMMENDED PAD LAYOUT (THROUGH-HOLE MODULE)



RECOMENDED P.W.B. PAD LAYOUT

NOTES:

DIMENSIONS ARE IN MILLIMETERS AND (INCHES)

TOLERANCES: $X.Xmm \pm 0.5mm$ ($X.XX$ in. ± 0.02 in.)

$X.XXmm \pm 0.25mm$ ($X.XXX$ in. ± 0.010 in.)



PART NUMBERING SYSTEM

E	48	S	H	120	10	N	R	F	A
Type of Product	Input Voltage	Number of Outputs	Product Series	Output Voltage	Output Current	ON/OFF Logic	Pin Length/Type		Option Code
E - Eighth Brick	48 - 36V~75V	S - Single	H - 50A series	120 - 12V	10 - 10A	N - Negative P - Positive	R - 0.170" N - 0.145" K - 0.110" M - SMD	F- RoHS 6/6 (Lead Free)	A - Standard Functions H - With heatspreader L - 175k fs & no heatspreader

RECOMMENDED PART NUMBER

MODEL NAME	INPUT		OUTPUT		EFF @ 100% LOAD
E48SH12010NRFA	36V~75V	3.9A	12V	10A	93%
E48SH12010NKFA	36V~75V	3.9A	12V	10A	93%
E48SH12010NRFL	36V~75V	3.9A	12V	10A	93%

Default remote on/off logic is negative and pin length is 0.170"

For different remote on/off logic and pin length, please refer to part numbering system above or contact your local sales office.

*** For modules with through-hole pins and the optional heatspreader, they are intended for wave soldering assembly onto system boards; please do not subject such modules through reflow temperature profile.**

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